



## Vishay General Semiconductor

## **Surface Mount Schottky Barrier Rectifiers**

# eSMP<sup>™</sup> Series





**Bottom View** 

**MicroSMP** 

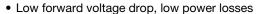
PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	1.0 A				
V <sub>RRM</sub>	30 V, 40 V				
I <sub>FSM</sub>	25 A				
V <sub>F</sub> at I <sub>F</sub> = 1.0 A	0.41 V				
T <sub>J</sub> max.	150 °C				

### **TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, dc-to-dc converters, and polarity protection applications.

## **FEATURES**

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement



High efficiency



- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

#### **MECHANICAL DATA**

Case: MicroSMP

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free and RoHS compliant,

commercial grade

Base P/NHM3 - halogen-free and RoHS compliant, automotive grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	MSS1P3	MSS1P4	UNIT	
Device marking code		13	14		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	30	V		
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub>	1.0		А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	25		А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to + 150		°C	

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum instantaneous forward voltage	$I_F = 0.5 A$	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.41	-	V
	I <sub>F</sub> = 1.0 A			0.48	0.55	
	I <sub>F</sub> = 0.5 A	- T <sub>J</sub> = 125 °C		0.32	-	
	I <sub>F</sub> = 1.0 A			0.41	0.46	
Maximum reverse current	Datad V	T <sub>J</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	8.5	200	μΑ
	Rated V <sub>R</sub>	T <sub>J</sub> = 125 °C	IR (=)	4.5	15	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	50	-	pF

#### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

# **MSS1P3, MSS1P4**

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THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	MSS1P3	MSS1P4	UNIT	
	R <sub>θJA</sub> <sup>(1)</sup>	125		°C/W	
Typical thermal resistance	R <sub>0</sub> JL (1)	30			
	R <sub>0</sub> JC (1)	40			

#### Note

(1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 6.0 mm x 6.0 mm copper pad areas R<sub>BJL</sub> is measured at the terminal of cathode band. R<sub>BJC</sub> is measured at the top center of the body

ORDERING INFORMATION (Example)						
PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE B		BASE QUANTITY	DELIVERY MODE			
MSS1P4-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel		
MSS1P4HM3/89A (1)	0.006	89A	4500	7" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified

## **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

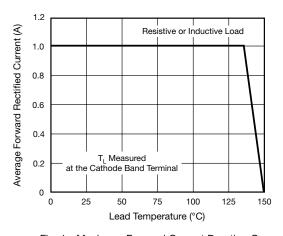


Fig. 1 - Maximum Forward Current Derating Curve

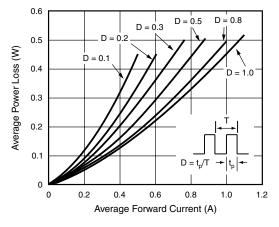


Fig. 2 - Forward Power Loss Characteristics

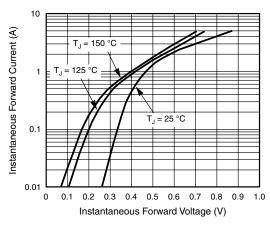


Fig. 3 - Typical Instantaneous Forward Characteristics

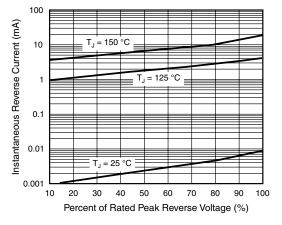


Fig. 4 - Typical Reverse Characteristics





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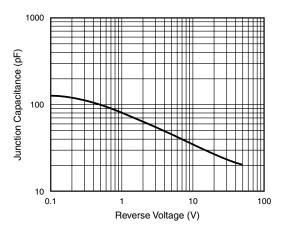


Fig. 5 - Typical Junction Capacitance

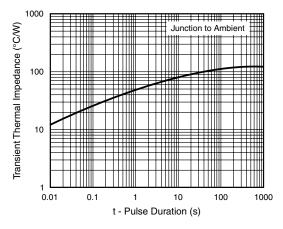
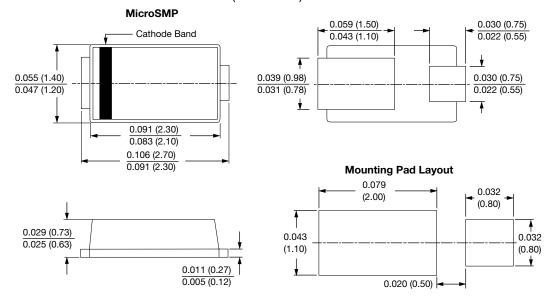


Fig. 6 - Typical Transient Thermal Impedance

## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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